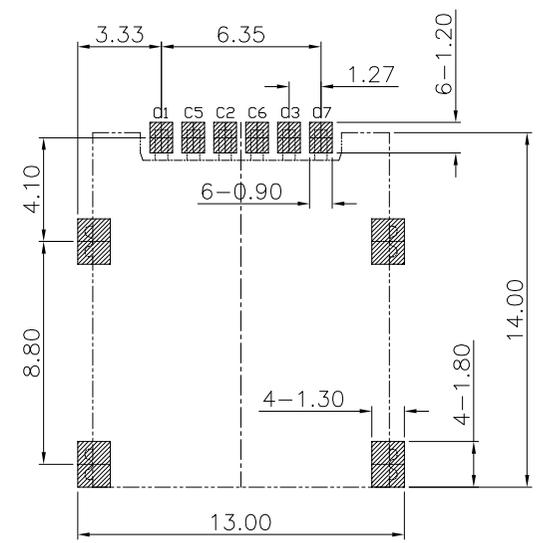
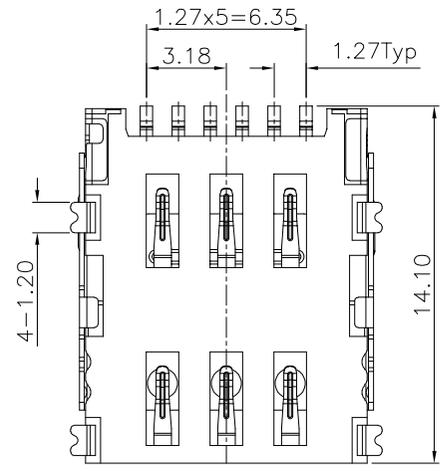
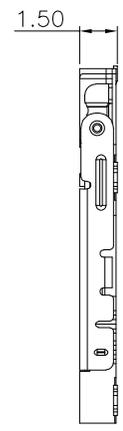
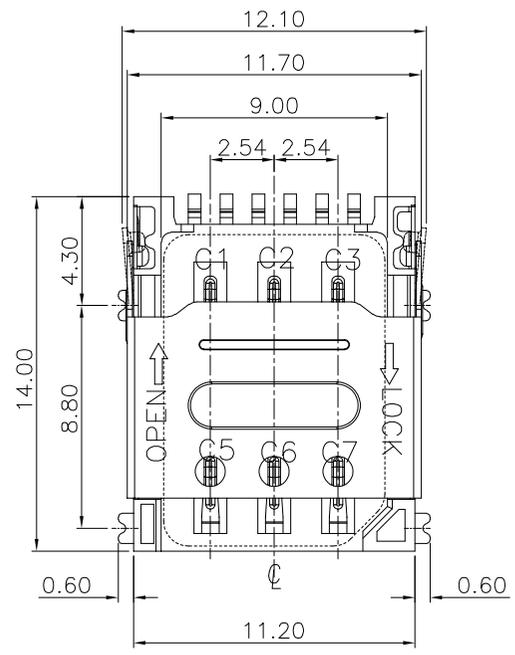
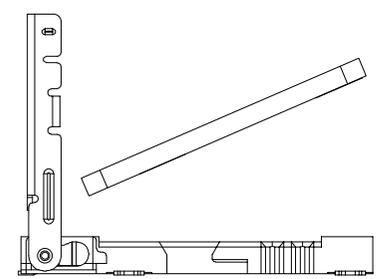
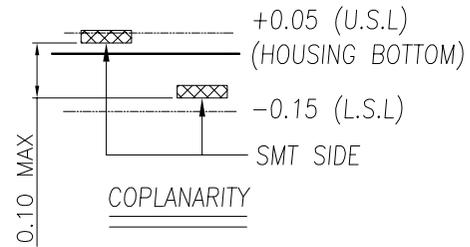
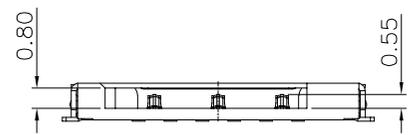


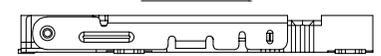
Rev No.	Description of Revision	Date	Name	Approved	ECN No.
▲X					



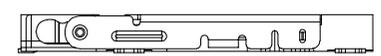
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



STEP 1 INSERT Micro-SIM CARD

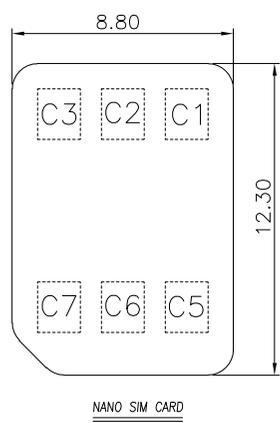


STEP 2 PUSH THE SHELL



STEP 3 FINISH

SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



NOTES:

- ELECTRICAL CHARACTERISTICS
 - CONTACT RESISTANCE: 60 Milliohms Max
 - INSULATION RESISTANCE: 1,000 Megohms Min.
 - VOLTAGE RATING: 50V.
 - CURRENT RATING: 1.0A.
- MECHANICAL CHARACTERISTICS
 - OPERATION TEMPERATURE RANGE: -20°C~+85°C
 - DURABILITY: 5000 CYCLES
- MATERIAL:
 - HOUSING: THERMOPLASTIC,UL 94-V0
 - TERMINAL: PHOSPHOR BRONZE,T=0.15
 - SHELL: STAINLESS STEEL,T=0.20
- FINISHED:
 - TERMINAL: Ni PLATED UNDER, 3U" Au MIN PLATED ON CONTACT AREA,AU PLATED ON SOLDER TAIL

UNLESS OTHERWISE SPECIFIED TOLERANCES		B Bossie (博锡)			
		TITLE: 翻盖式 NanoSIM卡卡座			
DECIMALS:	ANGLES	Drawn.	PART NO	BX-SMN-1.4HJ	
X. ±0.20	X°. ±2°	Checked.	SCALE: 3:10		
X.X ±0.15	X.X° ±1°	Approved.	SIZE: A4	SHEET: 1 OF 1	REV. A
X.XX ±0.10	X.XX° ±0.5°				
X.XXX ±0.05					
CUSTOMER COPY					